

F5D1/2/3 AIGaAs INFRARED EMITTING DIODE

PACKAGE DIMENSIONS 0.209 (5.31) 0.184 (4.67) 0.030 (0.76) 0.255 (6.48) NOM 1.00 (25.4) MIN ANODE (CASE) -0.100 (2.54) 0.050 (1.27) 0.040 (1.02) Ø0.020 (0.51) 2X 0.040 (1.02) NOTES:

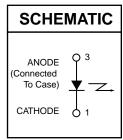
- 1. Dimensions for all drawings are in inches (mm).
- 2. Tolerance of ± .010 (.25) on all non-nominal dimensions unless otherwise specified.

DESCRIPTION

 The F5D series is a 880 nm LED in a narrow angle, TO-46 package.

FEATURES

- · Good optical to mechanical alignment
- Mechanically and wavelength matched to the TO-18 series phototransistor
- · Hermetically sealed package
- · High irradiance level



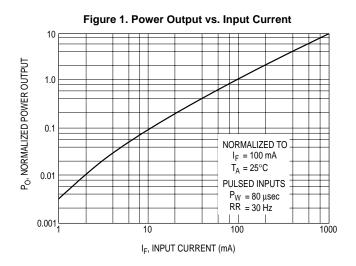
- 1. Derate power dissipation linearly 1.70 mW/°C above 25°C ambient.
- 2. Derate power dissipation linearly 13.0 mW/°C above 25°C case.
- 3. RMA flux is recommended.
- Methanol or isopropyl alcohols are recommended as cleaning agents.
- 5. Soldering iron tip 1/16" (1.6mm) minimum from housing.
- 6. As long as leads are not under any stress or spring tension
- 7. Total power output, P_O , is the total power radiated by the device into a solid angle of 2 π steradians.

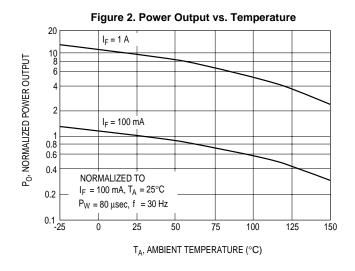
Parameter	Symbol	Rating	Unit
Operating Temperature	T _{OPR}	-65 to +125	°C
Storage Temperature	T _{STG}	-65 to +150	°C
Soldering Temperature (Iron)(3,4,5 and 6)	T _{SOL-I}	240 for 5 sec	°C
Soldering Temperature (Flow)(3,4 and 6)	T _{SOL-F}	260 for 10 sec	°C
Continuous Forward Current	I _F	100	mA
Forward Current (pw, 10µs; 100Hz)	I _F	3	А
Forward Current (pw, 1µs; 200Hz)	I _F	10	Α
Reverse Voltage	V _R	3	V
Power Dissipation (T _A = 25°C) ⁽¹⁾	P _D	170	mW
Power Dissipation (T _C = 25°C) ⁽²⁾	P _D	1.3	W

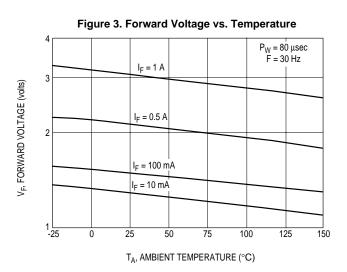
ELECTRICAL / OPTICAL CHARACTERISTICS (TA =25°C) (All measurements made under pulse conditions)									
PARAMETER	TEST CONDITIONS	SYMBOL	MIN	TYP	MAX	UNITS			
Peak Emission Wavelength	$I_F = 100 \text{ mA}$	λ_{P}	_	880	_	nm			
Emission Angle at 1/2 Power	I _F = 100 mA	θ	_	±8	_	Deg.			
Forward Voltage	$I_F = 100 \text{ mA}$	V_{F}	_	_	1.7	V			
Reverse Leakage Current	$V_R = 3 V$	I _R	_	_	10	μΑ			
Total Power F5D1(7)	$I_F = 100 \text{ mA}$	Po	12.0	_	_	mW			
Total Power F5D2(7)	$I_F = 100 \text{ mA}$	Po	9.0	_	_	mW			
Total Power F5D3(7)	$I_F = 100 \text{ mA}$	Po	10.5	_	_	mW			
Rise Time 0-90% of output		t _r	_	1.5	_	μs			
Fall Time 100-10% of output		t _f	_	1.5	_	μs			

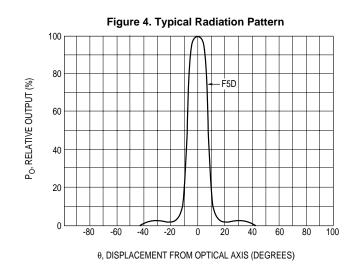


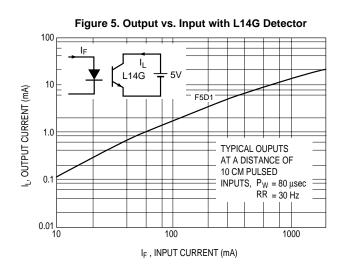
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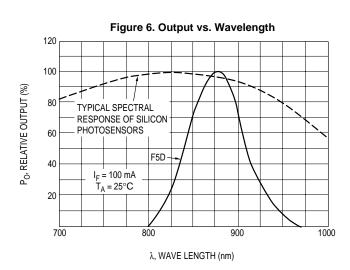














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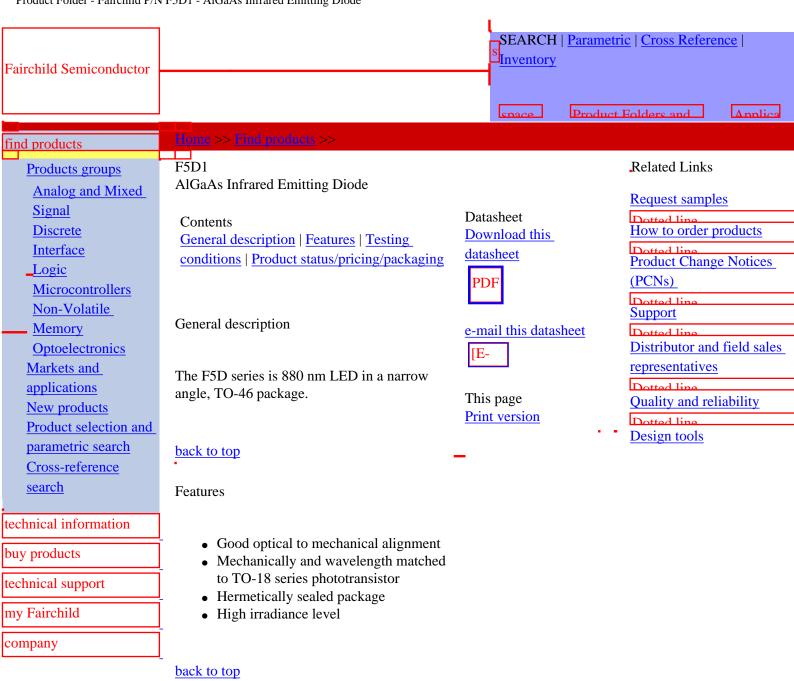
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Testing conditions

• $P_0 @ I_F = 100 \text{ mA}$

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Product status/pricing/packaging

Product	Product status	Pricing*	Inventory check & ordering	Package type	Packing method
F5D1	Full Production	\$1.00	Purchase	TO-46	BULK
F5D1B	Full Production	N/A	Purchase	TO-46	BULK

Product Folder - Fairchild P/N F5D1 - AlGaAs Infrared Emitting Diode

* Fairchild 1,000 piece Budgetary Pricing

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